



Institute for
Mathematics
and
its Applications

UNIVERSITY OF MINNESOTA

Twin Cities

+ 1 612 624-6066
Fax 612 626-7370

400 Lind Hall, 207 Church St. SE
Minneapolis, MN 55455

Email: staff@ima.umn.edu
URL: www.ima.umn.edu

January 3, 2007

TO WHOM IT MAY CONCERN

This letter is submitted in support of the non-immigrant status application for WB status or a B-1 business visa for Dr. Henry Wolkowicz.

The Institute for Mathematics and its Applications (IMA) at the University of Minnesota has invited Dr. Wolkowicz to spend one week during the period of January 14th to January 20th. Dr. Wolkowicz's activities will include participation in the workshop *Optimization and Control*, as well as interaction with other workshop attendees and visitors in residence at the IMA.

As an invited business visitor, the University of Minnesota will reimburse Dr. Wolkowicz only for travel, lodging, meals, conference and other expenses based on actual receipts for these items. No payment in excess of actual expenses will be made.

Therefore, we respectfully ask that Dr. Wolkowicz be issued WB or B1 status for entry into the United States for the above business purpose.

Sincerely,

Douglas N. Arnold
Professor and Director, IMA
400 Lind Hall, 207 Church Street S.E.
University of Minnesota
Minneapolis, MN 55455

PARTICIPATING INSTITUTIONS: Air Force Research Laboratory, Carnegie Mellon University, Consiglio Nazionale delle Ricerche, Georgia Institute of Technology, Indiana University, Iowa State University, Kent State University, Lawrence Livermore National Laboratory, Los Alamos National Laboratory, Michigan State University, Michigan Technological University, Mississippi State University, Northern Illinois University, Ohio State University, Pennsylvania State University, Purdue University, Rice University, Rutgers University, Sandia National Laboratory, Seoul National University, Texas A&M University, University of Chicago, University of Cincinnati, University of Delaware, University of Houston, University of Illinois (Urbana), University of Iowa, University of Kentucky, University of Maryland, University of Michigan, University of Minnesota, University of Notre Dame, University of Pittsburgh, University of Texas, University of Wisconsin, University of Wyoming, Wayne State University, Worcester Polytechnic Institute.

PARTICIPATING CORPORATIONS: 3M, Boeing, Corning, ExxonMobil, Ford, General Electric, General Motors, Honeywell, IBM, Johnson & Johnson, Lockheed Martin, Medtronic, Motorola, Schlumberger, Siemens, Telcordia Technologies.